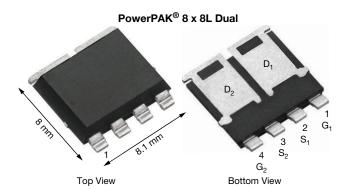
## SQJQ906EL

www.vishay.com

**Vishay Siliconix** 

# Automotive Dual N-Channel 40 V (D-S) 175 °C MOSFET



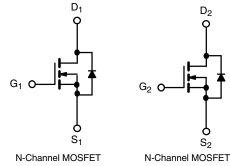
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	40			
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0043			
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS}$ = 4.5 V	0.0054			
I <sub>D</sub> (A) per leg	160			
Configuration	Dual			
Package	PowerPAK 8 x 8L			

### **FEATURES**

- TrenchFET<sup>®</sup> power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Fully lead (Pb)-free device
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



RoHS COMPLIANT HALOGEN FREE



ABSOLUTE MAXIMUM RATING	<b>S</b> (T <sub>C</sub> = 25 °C, unless	otherwise noted	)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	40	- V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
Continuous Drain Current	T <sub>C</sub> = 25 °C <sup>a</sup> T <sub>C</sub> = 125 °C	- I <sub>D</sub>	160		
	T <sub>C</sub> = 125 °C		67		
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	170	А	
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	640		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	27		
Single Pulse Avalanche Energy		E <sub>AS</sub>	36	mJ	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	Р	187	W	
	T <sub>C</sub> = 125 °C	PD PD	62	vv	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering Recommendations (Peak Temperature) d, e			260	C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount <sup>c</sup>	R <sub>thJA</sub>	60	°C/W
nction-to-Case (Drain)		R <sub>thJC</sub>	0.8	C/W

#### Notes

a. Package limited.

b. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%.$ 

c. When mounted on 1" square PCB (FR4 material).

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 8 x 8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

S16-1762-Rev. A, 05-Sep-16	1	Document Number: 75615
For tech	nnical questions, contact: <u>automostechsupport@vishay.c</u>	<u>com</u>
	ANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBE	
ARE SUBJECT TO S	SPECIFIC DISCLAIMERS. SET FORTH AT www.vishav.co	om/doc?91000

www.vishay.com

SQJQ906EL Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static		-			•		<u></u>	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 250 \ \mu A$ $V_{DS} = V_{GS}, I_D = 250 \ \mu A$		40	-	-	v	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>			1.5	2	2.5		
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 20 V	-	-	1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 125 °C	-	-	50	μA	
		$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	150		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	40	-	-	Α	
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 10 V$	I <sub>D</sub> = 5 A	-	0.0036	0.0043	Ω	
		$V_{GS} = 4.5 V$	I <sub>D</sub> = 5 A	-	0.0045	0.0054		
	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 5 A, T <sub>J</sub> = 125 °C	-	-	0.0082		
		$V_{GS} = 10 V$	I <sub>D</sub> = 5 A, T <sub>J</sub> = 175 °C	-	-	0.0100		
Forward Transconductance b	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		-	86	-	S	
Dynamic <sup>b</sup>		-			-			
Input Capacitance	C <sub>iss</sub>		V <sub>DS</sub> = 20 V, f = 1 MHz	-	2590	3238	pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	1785	2230		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	102	130		
Total Gate Charge <sup>c</sup>	Qg		V V <sub>DS</sub> = 20 V, I <sub>D</sub> = 10 A	-	35	45	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	6	-		
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			-	4	-		
Gate Resistance	Rg	f = 1 MHz		0.7	1.1	1.9	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	10	14		
Rise Time <sup>c</sup>	t <sub>r</sub>	V <sub>DD</sub>	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{I}} = 2 \Omega$		3	5	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 10$ Å, $V_{GEN} = 10$ V, $R_g = 1$ $\Omega$		-	25	35		
Fall Time <sup>c</sup>	t <sub>f</sub>			-	3	5		
Source-Drain Diode Ratings and Char	acteristics <sup>b</sup>							
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	600	Α	
Forward Voltage	V <sub>SD</sub>	$I_F = 40 \text{ A}, V_{GS} = 0$		-	1	1.2	V	

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

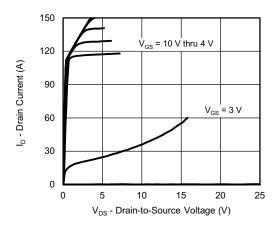
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

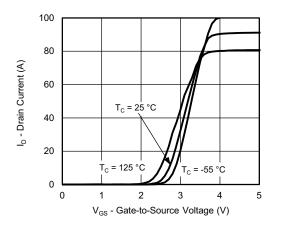


**Vishay Siliconix** 

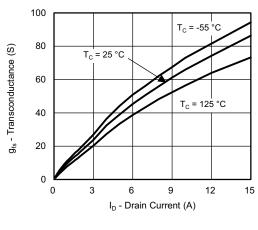
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



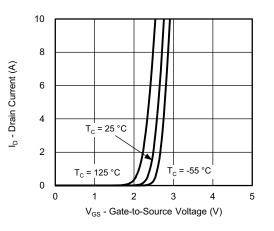
**Output Characteristics** 



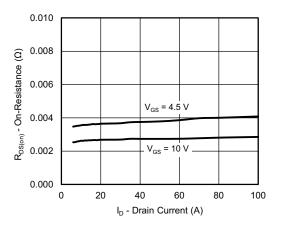
**Transfer Characteristics** 



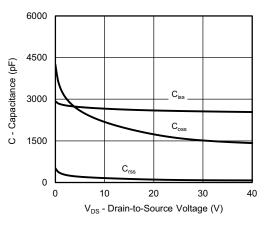
Transconductance



**Transfer Characteristics** 



**On-Resistance vs. Drain Current** 



#### Capacitance

S16-1762-Rev. A, 05-Sep-16

3 ons\_contact: automostechsu Document Number: 75615

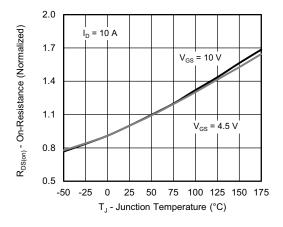
For technical questions, contact: <u>automostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



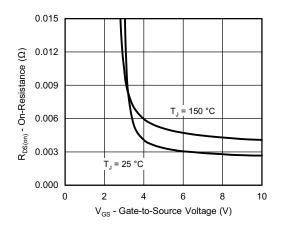
# SQJQ906EL

**Vishay Siliconix** 

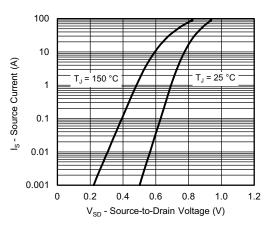
### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



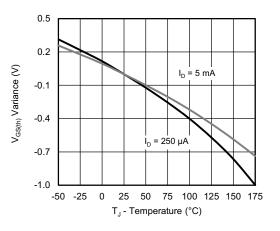
**On-Resistance vs. Junction Temperature** 

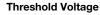


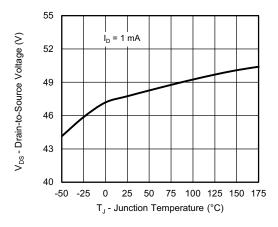
**On-Resistance vs. Gate-to-Source Voltage** 



Source Drain Diode Forward Voltage







Drain Source Breakdown vs. Junction Temperature

4

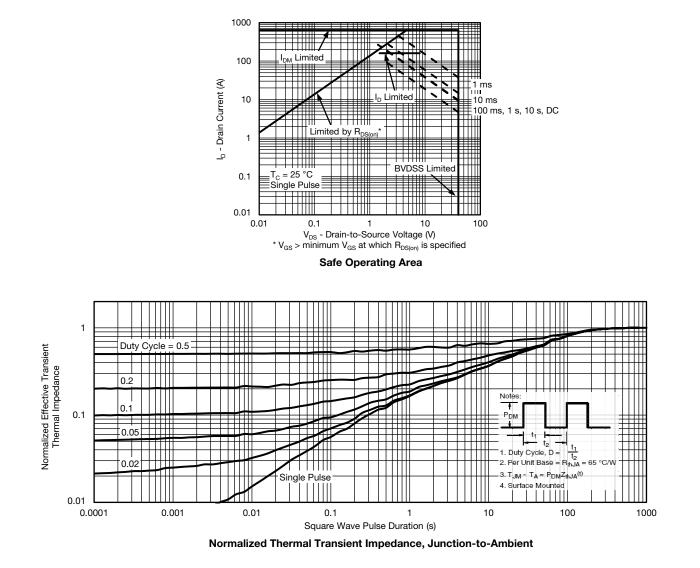
For technical questions, contact: <u>automostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



SQJQ906EL

**Vishay Siliconix** 

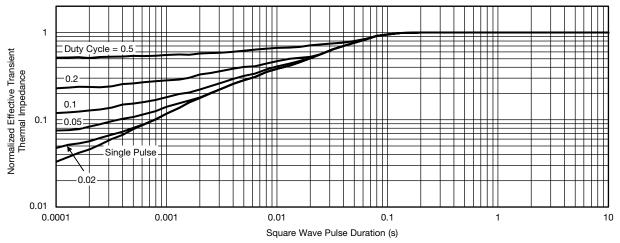
### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)





## Vishay Siliconix

THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction to Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?75615.

6



Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.